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Typical Electrical & Optical Characteristics (IF=350mA and Ta=25°C)

Part-No.	Dominant Wavelength (nm) or CCT(K) X / Y corod.		Forward Voltage (V)		Luminious Flux (lm)		Cur-rent (mA)	50% Power Angle
	X	Y	Min	Max	Min	Typ	max	Typ
M11A1325	0,44	0,42	3,2	3,6	19	25	150	120

1. Tolerance of measurement of luminous flux : +/-15% 2. Tolerance of measurement of dominant Wavelength : +/-1nm

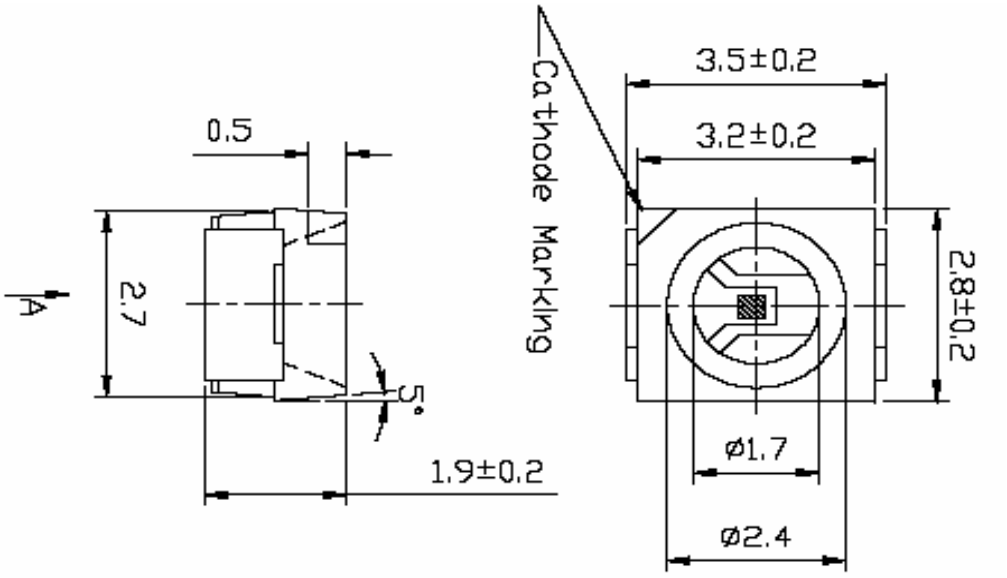
3. Tolerance of measurement of CCT (Correlated color temperature +/- 200K

4. Tolerance of measurement of forward voltage +/-0,1V

Features

Contour Lights
Garden Lighting
Genral Lighting
Reading Lights

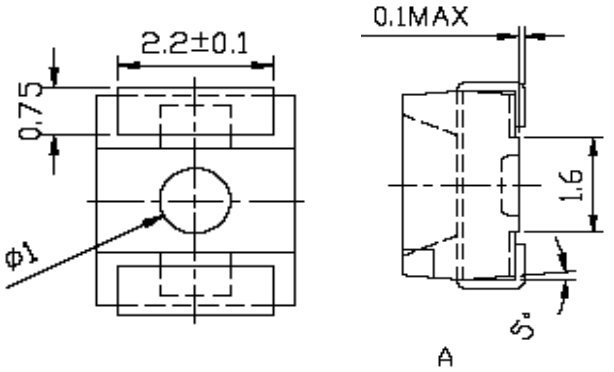
Technical Dimensions

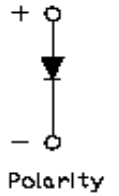


Absulut Maximum Ratings (Ta=25°C)

Items	Symbols	Absulut maximum Rating	Unit
		Red	
Power Dissipation	Pd	850	mW
Forward Current	If	350	mA
Peak Forward Current	Ifp	500	Ma
LED Junction Temperature	Tj	125	°C
Operating Temperature	Topr	.-30°C ~ +110°C	°C
Storage Temperature	Tstg	.-40°C ~ +120°C	°C

* Pulse width ≤ 0,1msec duty ≤ 1/10





SMD DIAMOND TOP-LED

Part No.: **M11A1325**

Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.07.2010
APPD:	Schumi			FINISH	Jamy		Sheet No.		1 from 10

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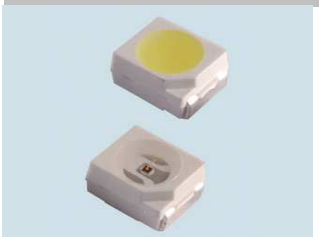

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BIN GUIDE / HIGH POWER

Code	Luminous Flux Range		Code	Luminous Flux Range	
	min	max.		min	max.
A	1	2	P2	70	80
B	2	2,5	M1	80	90
C	2,5	3,2	M2	90	100
D	3,2	4	N1	100	110
E	4	5	N2	110	120
F	5	6,2	P1	120	130
G	6,2	7,7	P2	130	140
H	7,7	9,6	Q1	140	150
J	9,6	12	Q2	150	160
K	12	15	R1	160	170
L1	15	19	R2	170	180
L2	19	24	S1	180	200
M1	24	30	S2	200	220
M2	30	40	T1	220	240
N1	40	50	T2	240	260
N2	50	60	U1	250	280
P1	60	70			

Tolerance of measurement of luminous Flux is +/- 15%

Code	CCT Range		Code	CCT Range	
	Min	Max		Min	Max
A	2700	2900	M	4900	5100
B	2900	3100	N	5100	5500
C	3100	3300	P	5500	6000
D	3300	3500	Q	6000	6500
E	3500	3700	R	6500	7000
F	3700	3900	S	7000	7500
G	3900	4100	T	7500	8000
H	4100	4300	U	8000	9000
J	4300	4500	V	9000	10000
K	4500	4700	W	10000	12000
L	4700	4900			

Tolerance of measurement of CCT is +/-100K.

	B		H		G/E		F		Y		Q/P		R/U	
Color Code	Min	max	Min	max	Min	max	Min	max	Min	max	Min	max	Min	max
D0	450	455	490	495	515	520	560	565	580	583	600	605	620	625
D1	455	460	495	500	520	525	565	570	583	586	605	610	625	630
D2	460	465	500	505	525	530	570	575	586	589	610	615	630	635
D3	465	470	505	510	530	535	575	580	589	592	615	620	635	640
D4	470	475	510	515	535	540			592	595			640	645
D5	475	480			540	545			595	598			645	650
D6	480	485			545	550							650	655
D7	485	490			550	555							655	660
D8					555	560							660	665

Tolerance of measurement of dominant wavelength is +/-1nm

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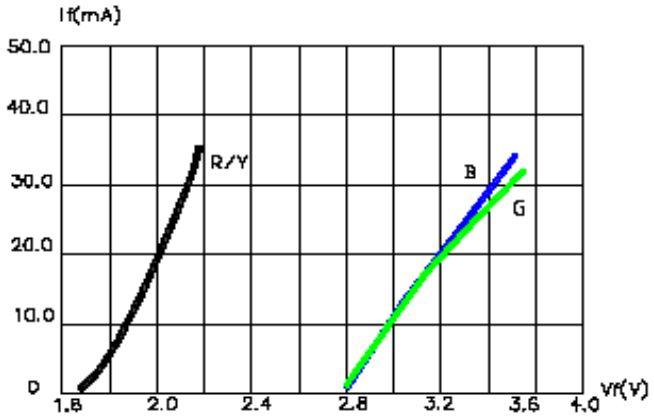
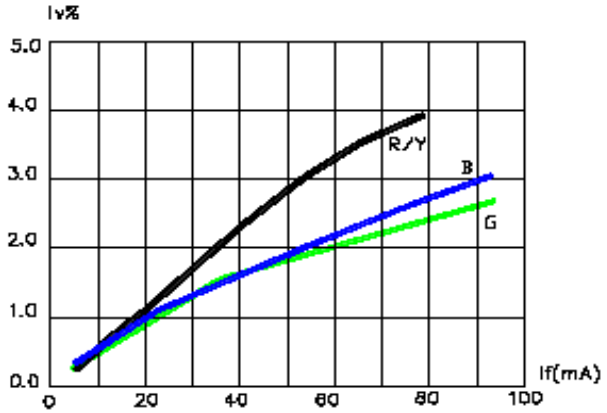
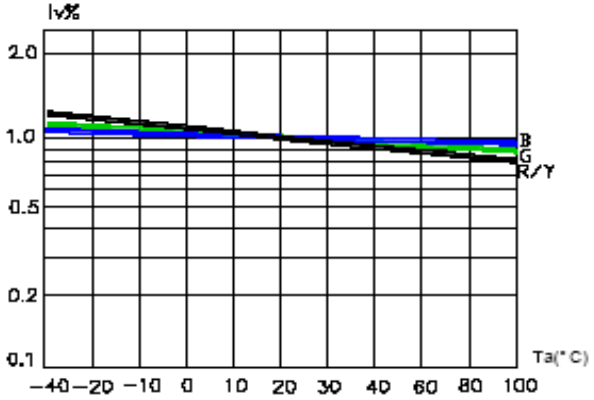
Typical Electrical / Optical Characteristics Curves (Ta=25°C Unless otherwise noted)



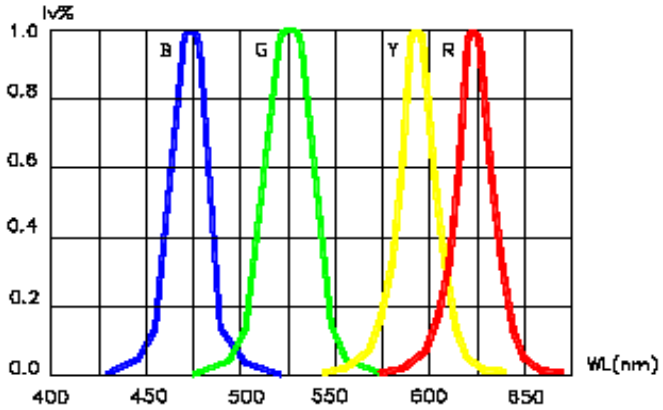
Forward Current vs. Forward Voltage



Relative Luminous Intensity vs. Forward Current



Relative Luminous Intensity vs. Ambient Temperature



Relative Luminous Intensity vs. Wavelength

Code	Forward Voltage Rank	
	Min.	Max.
A	1,6	1,8
B	1,8	2,0
C	2,0	2,2
D	2,2	2,4
E	2,4	2,6
F	2,6	2,8
G	2,8	3,0
H	3,0	3,2

Tolerance of measurement of forward voltage is +/-0,1V

Code	Forward Voltage Rank	
	Min.	Max.
J	3,20	3,40
K	3,40	3,60
L	3,60	3,80
M	3,80	4,00
N	4,00	4,20
P	4,20	4,40
Q	4,40	4,60
R	4,60	4,80

SMD DIAMOND TOP-LED

Part No.: **M11A1325**

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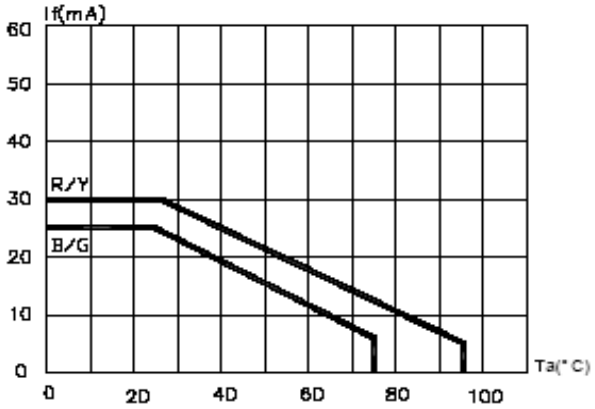
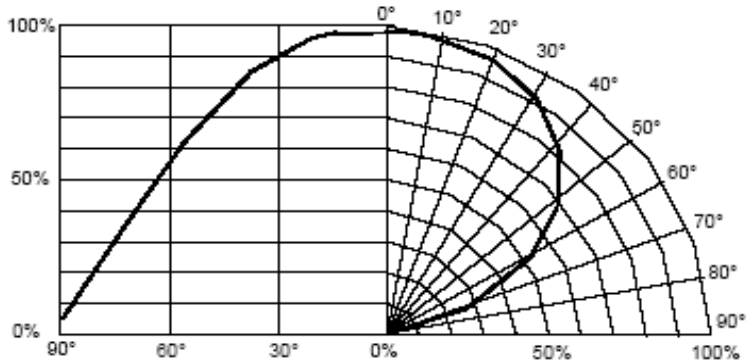
Typical Representative Spatial Radiation Paddern of single LED

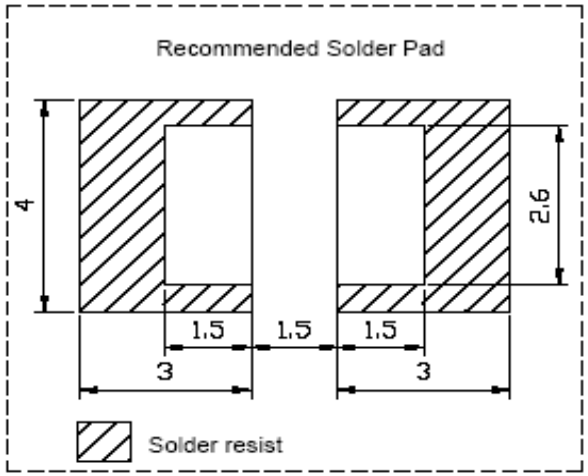


Maximum Forward Current vs.Ambient Temperature



Radiation Angle

PCB PAD Layout Dimensions



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Handling Informations

4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.

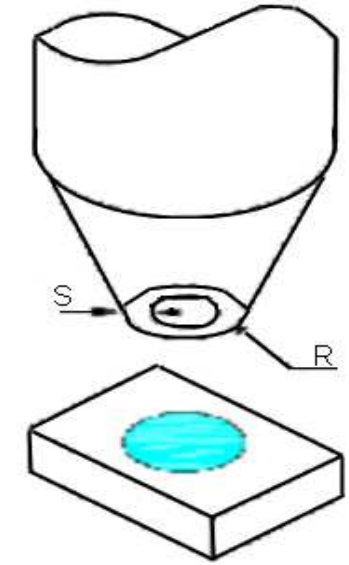
5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.

6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.

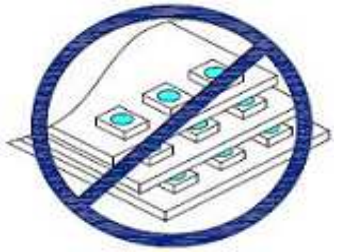
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools

2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratsch the silicone lens or damage the internal circuitry.



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Moisture Proof Packing

In Order to prevent moisture absorption into DIAMOND = TOP LED / XEON POWER during the transportation and storage. DIAMOND TOP-LED / XEON-POWER LED is packed in a moisture barrier bag. Desiccants and humidity indicator are packed together with DIAMOND TOP-LED / XEON-POWER LED as the secondary protection.
The indication of humidity card provides the information of humidity within TOP Packing.

Storage

Shelf life in original sealed bag in storage condition of <40°C and 90% RH is 12 mounths. Baking is required whenever shelf life is expired. Before opening the packaging please check wether bag leak air or not. After opening the DIAMOND TOP-LED / XEON POWER LED must be storad under the condition <30°C and 60% RH. Under this condition DIAMOND TOP-LED / XEON POWER LED must be used (subject to reflow) within 24-hours after bag opening, and re-baking is required when exceeding 24 hours.
For baking, place DIAMOND TOP-LED / XEON POWER LED in oven at temperature 75°C +/-5°C and relative humidity <10%RH, for 24 hours. Take out the material from packaging bag for re-bake. Do not open the door of oven frequently during the baking process.
Manual soldering (We do not recommend this method strongly).
No mechanical stress should be exerted on the resin portion of DIAMOND TOP-LED / XEON POWER during soldering.
Handling of DIAMOND TOP-LED / XEON POWER LED should be done when the package has been cooled down to below 40°C or less. This is to prevent the DIAMOND TOP-LED / XEON POWER failures due the thermal-mechanical strss during handling.
Reflow soldering should not be done more than one time.
No stress should be exerted on the package during soldering.
Electrostatic Discharge and Surge current.
Electrostatic discharge (ESD) or surge current (EOS) may damage LED.
Precautions such as ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling DIAMOND TOP-LED / XEON POWER LED.
All devices, equipment and machinery must be prpertly grounded.
It is recommended to perform electrical test to screen out ESD failures in final inspection.
It is importatn to eliminate the possibility of surge current during circuity design.

Heat Management
Heat manegement of DIAMOND TOP-LED / XEON POWER must be taken into into consideration during the design stage of DIAMOND TOP-LED / XEON POWER LED application. The current should be de-rated appropriately by refering to the de-rating curve attached on each product specification.

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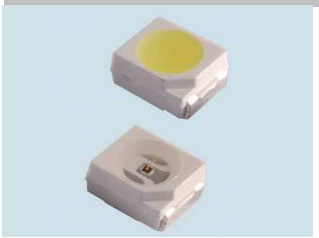

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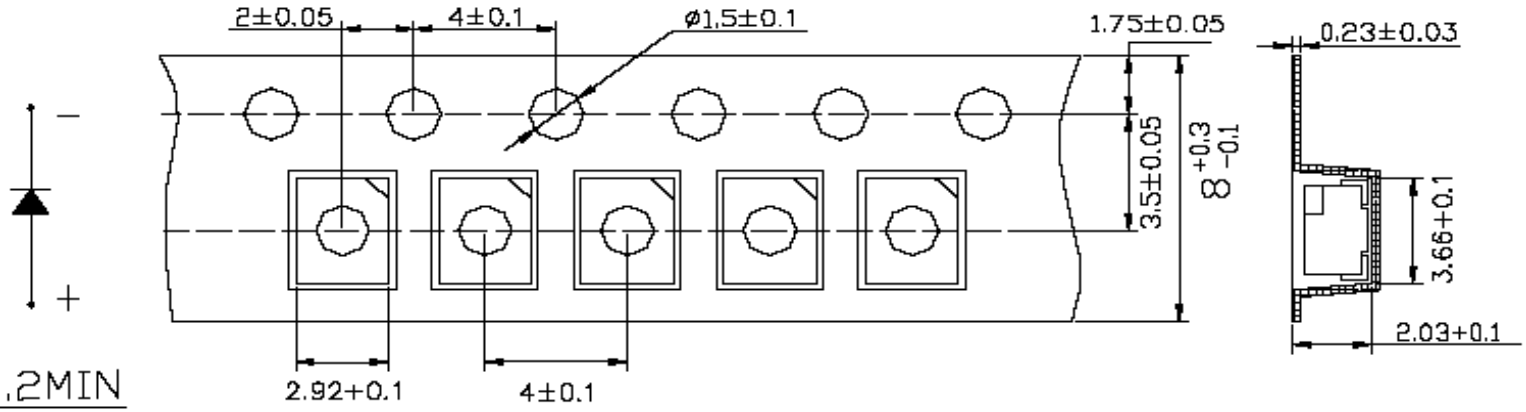
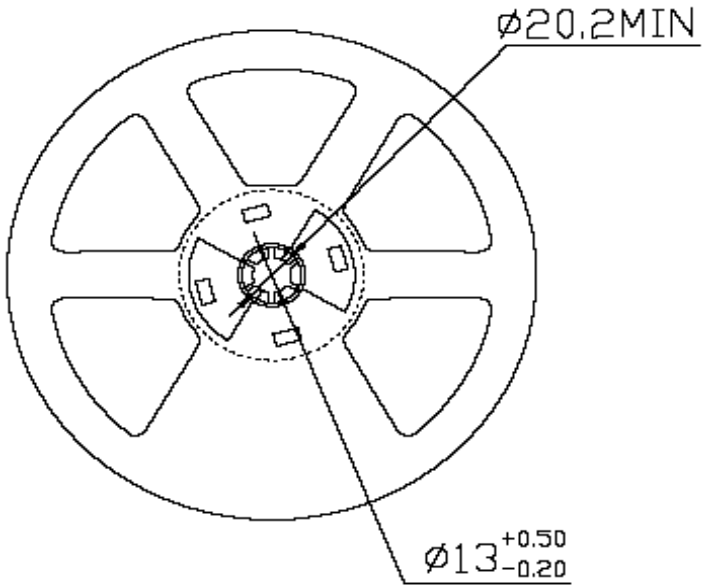
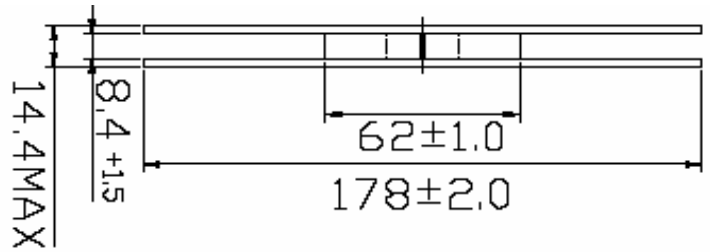
Packing Specifications







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Ordering Informations

Serie	Color Code	ROHS	Packing							
M11A1325	**WW**	**R**	**TR**							

WW= Warm White	**R**= ROHS Conform	**TR**= TAPE REEL
	N= NON ROHS	**BU**= Bulk-Ware

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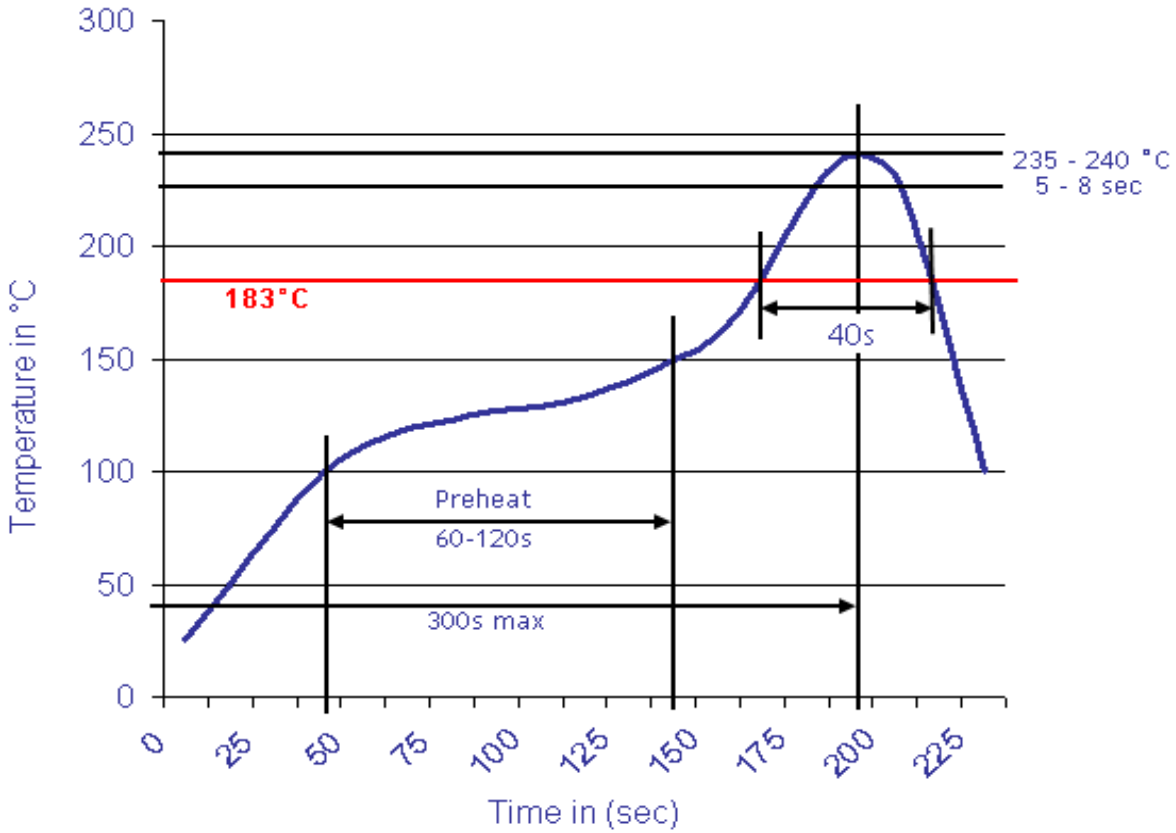
Soldering Profile Curve

Classification Reflow Profile (JEDEC J-STD-020C)



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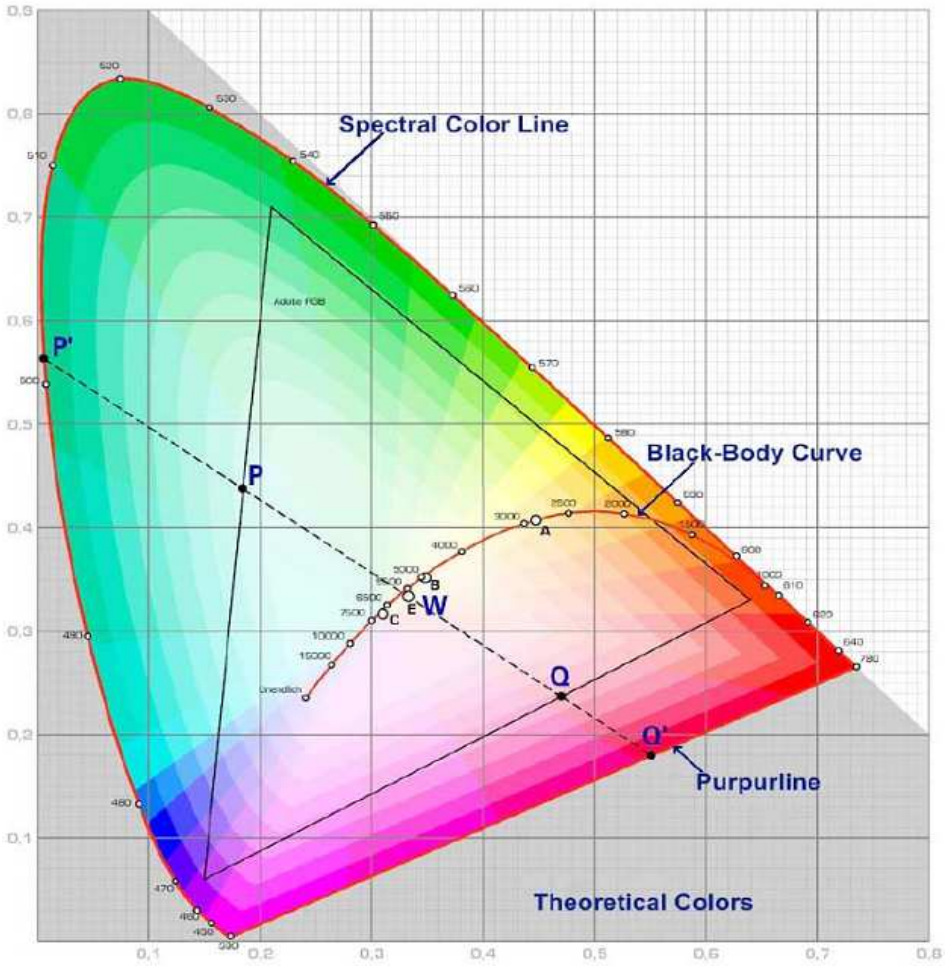
Spectral Color Curve



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